



13.3 inch E-paper Display Series

GDEY133F91

Dalian Good Display Co., Ltd.



Product Specifications



Customer	Standard
Description	13.3" EPAPER DISPLAY
Model Name	GDEY133F91
Date	2025/07/17
Revision	1.0

	Design Engineering		
	Approval	Check	Design
			

No.18, Zhonghua West ST, Ganjingzi DST, Dalian, CHINA

Tel: +86-411-84619565

Email: info@good-display.com

Website: www.good-display.com

CONTENTS

1.	Over View.....	5
2.	Features	5
3.	Mechanical Specification.....	5
4.	Mechanical Drawing of EPD Module.....	6
5.	Input/output Pin Assignment.....	7
6.	Electrical Characteristics.....	8
	6.1 Absolute Maximum Rating.....	8
	6.2 Panel DC Characteristics.....	9
	6.3 Panel AC Characteristics.....	10
	6.3.1 MCU Interface Selection.....	10
	6.3.2 MCU Serial Interface (4-wire SPI).....	10
	6.3.3 MCU Serial Interface (3-wire SPI).....	11
7.	Command Table.....	12
8.	Handling, Safety, and Environment Requirements.....	25
9.	Optical specifications.....	25
10.	Reliability Test.....	26

11. Reference Circuit.....	27
12. Matched Development Kit.....	28
13. Inspection condition.....	29
14. Packaging.....	32
15. Precautions.....	34

GOOD DISPLAY

1. Over View

GDEY0266F51H is a reflective electrophoretic technology display module on an active matrix TFT substrate. The panel is capable of displaying black, white, yellow and red images depending on the associated lookup table used. The circuitry on the panel includes an integrated gate and source driver, timing controller, oscillator, DC-DC boost circuit, and memory to store the frame buffer and lookup tables, and additional circuitry to control VCOM and BORDER settings.

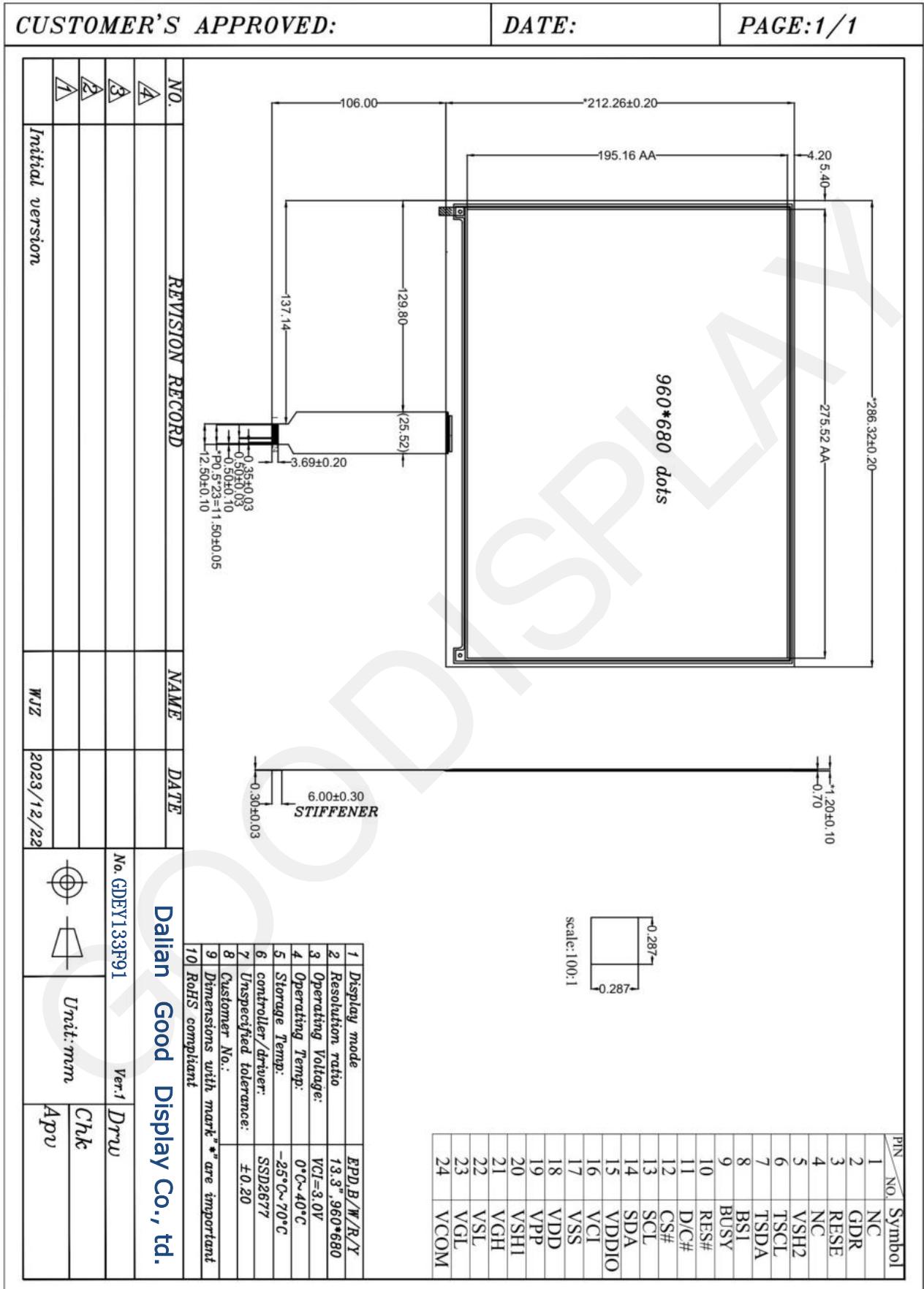
2. Features

- Highlight Red and Yellow color
- High contrast
- High reflectance
- Ultra wide viewing angle
- Ultra low power consumption
- Pure reflective mode
- Bi-stable display
- Antiglare hard-coated front-surface
- Low current deep sleep mode
- On chip display RAM
- Waveform stored in On-chip OTP
- Serial peripheral interface
- On-chip oscillator
- On-chip booster and regulator control for generating VCOM, Gate and Source driving voltage
- I²C signal master interface to read external temperature
- sensor Available in COG package

3. Mechanical Specifications

Parameter	Specifications	Unit	Remark
Screen Size	13.3	Inch	
Display Resolution	960(H)×680(V)	Pixel	Dpi:88
Active Area	275.52×195.16	mm	
Pixel Pitch	0.287×0.287	mm	
Pixel Configuration	Rectangle		
Outline Dimension	286.32(H)×212.26(V) ×1.2(D)	mm	
Weight	140.80±0.50	g	

4. Mechanical Drawing of EPD module



5. Input /Output Pin Assignment

5.	Name	I/O	Description	Remark
1	NC		Do not connect with other NC pins	Keep Open
2	GDR	I/O	N-Channel MOSFET Gate Drive Control	
3	RESE	I/O	Current Sense Input for the Control Loop	
4	NC		Do not connect with other NC pins	Keep Open
5	VSH2	C	Positive Source driving voltage	
6	TSCL	O	This pin is I ² C Interface to digital temperature sensor Clock pin. External pull up resistor is required when connecting to I ² C slave. When not in use: Open	
7	TSDA	I/O	This pin is I ² C Interface to digital temperature sensor Data pin. External pull up resistor is required when connecting to I ² C slave. When not in use: Open	
8	BS1	I	Interface Selection Pin	
9	BUSY	O	Busy state output pin	
10	RES#	I	Reset	
11	D/C#	I	Data /Command control pin	
12	CS#	I	Chip select input pin	
13	SCL	I	Serial Clock pin (SPI)	
14	SDA	I/O	Serial Data pin (SPI)	
15	VDDIO	P	Power for interface logic pins	
16	VCI	P	Power Supply for the chip	
17	VSS	P	Ground	
18	VDD	P	Core logic power pin	
19	VPP	P	Reserved	
20	VSH1	C	Positive Source driving voltage	
21	VGH	C	Power Supply pin for VSH	
22	VSL	C	Negative Source driving voltage	
23	VGL	C	Power Supply pin for VCOM and VSL	
24	VCOM	C	VCOM driving voltage	

Key: I = Input, O =Output, I/O = Bi-directional (input/output), P = Power pin, C = Capacitor PinNC = Not Connected, Pull L =connect to GND, Pull H = connect to VDDIO

6. Electrical Characteristics

6.1 Absolute Maximum Rating

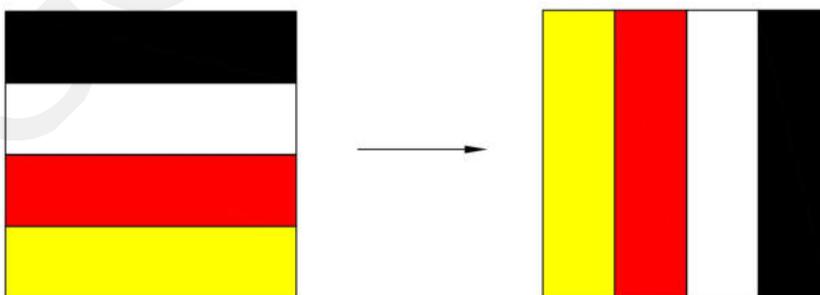
Parameter	Symbol	Rating	Unit
Logic supply voltage	VCI	-0.5 to +4.0	V
Logic Input voltage	VIN	-0.5 to $V_{DDIO} + 0.5$	V
Logic Output voltage	VOUT	-0.5 to $V_{DDIO} + 0.5$	V
Operating Temp range	TOPR	0 to +40	°C
Storage Temp range	TSTG	-25 to +70	°C
Optimal Storage Temp	TSTGo	23±2	°C
Optimal Storage Humidity	HSTGo	55±10	%RH

Note: Maximum ratings are those values beyond which damages to the device may occur. Functional operation should be restricted to the limits in the Electrical Characteristics tables or Pin Description section

6.2 Panel DC Characteristics

Parameter	Symbol	Conditions	Applicable pin	Min.	Typ.	Max	Units
Single ground	V _{SS}	-		-	0	-	V
VDD supply operation voltage	V _{CI}	-	VCI	2.3	3.0	3.6	V
High level input voltage	V _{IH}	-	-	0.8 V _{DDIO}	-	-	V
Low level input voltage	V _{IL}	-	-	-	-	0.2V _{DDIO}	V
High level output voltage	V _{OH}	IOH = -100uA	-	0.8V _{DDIO}	-	-	V
Low level output voltage	V _{OL}	IOL = 100uA	-	-	-	0.2V _{DDIO}	V
Typical power	P _{TYP}	V _{CI} = 3.0V	-	-	108	-	mW
Deep sleep mode	P _{STPY}	V _{CI} = 3.0V	-	-	0.003	-	mW
Typical operating current	Iopr_V _{CI}	V _{CI} = 3.0V	-	-	36	-	mA
Fast/Full image update	-	25 °C	-	-	20/25	-	sec
Sleep mode current	Islp_V _{CI}	DC/DC off No clock No input load Ram data retain	-	-	20	-	uA
Deep sleep mode current	Idslp_V _{CI}	DC/DC off No clock No input load Ram data not retain	-	-	1	-	uA

Notes: 1. The typical power is measured with following transition from horizontal 4 scale pattern to vertical 4 scale pattern.



2. The deep sleep power is the consumed power when the panel controller is in deep sleep mode.
3. The listed electrical/optical characteristics are only guaranteed under the controller & waveform provided by NEWFACE.
4. Electrical measurement: Multimeter

6.3 AC Characteristics

6.3.1 MCU Interface Selection

The IC can support 3-wire/4-wire serial peripheral. In the IC, the MCU interface is pin selectable by BS1 shown in Table 6-1.

Note

- (1) L is connected to GND
- (2) H is connected to VDDIO

Table 6-1 : Interface pins assignment under different MCU interface

MCU Interface	BS1	RST_N	CSB	DC	SCL	SDA
4-wire serial peripheral interface (SPI)	L	Required	CSB	D/C	SCL	SDA
3-wire serial peripheral interface (SPI) – 9 bits SPI	H	Required	CSB	L	SCL	SDA

6.3.2 MCU Serial Interface (4-wire SPI)

The 4-wire SPI consists of Serial Clock (SCL), Serial Data (SDA), Data/Command (D/C), and Chip Select Bar (CSB).

The control pin statuses for reading and writing commands/data using 4-wire SPI are shown in Table 6-2.

The read/write procedure of 4-wire SPI is illustrated in Figure 6-1.

Table 6-2: Control Pin Statuses of 4-wire SPI

Function	SCL pin	SDA pin	D/C pin	CSB pin
Write command	↑	Command bit	L	L
Read/Write data	↑	Data bit	H	L

Note:

- (1) L is connected to GND and H is connected to VDDIO
- (2) ↑ stands for rising edge of signal
- (3) SDA (Write Mode) is shifted into an 8-bit shift register on every rising edge of SCL in the order of D7, D6, ... D0. The level of D/C should be kept over the whole byte. The data byte in the shift register is written to the Graphic Display Data RAM (RAM)/Data Byte

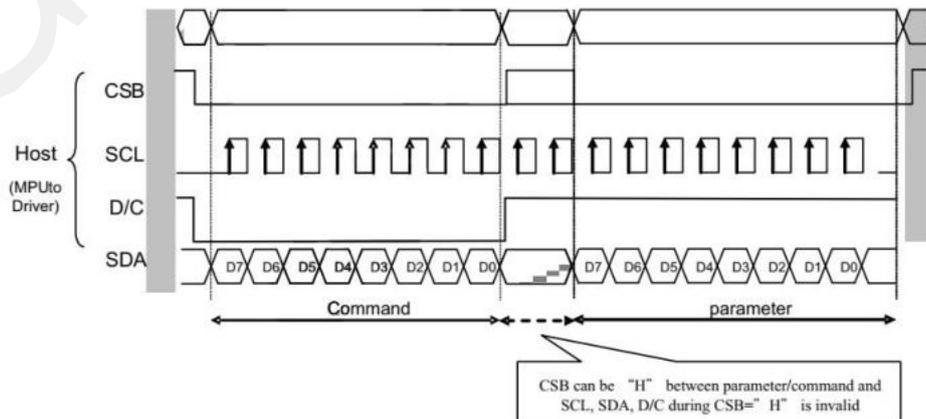


Figure 6-1 : Read/Write procedure in 4-wire SPI mode

6.3.3 MCU Serial Interface (3-wire SPI)

The 3-wire SPI consists of Serial Clock (SCL), Serial Data (SDA), and Chip Select Bar (CSB). Its operation is similar to the 4-wire SPI, except that the D/C pin is not used and must be tied to LOW. The control pin status in 3-wire SPI is shown in Table 6-3, and the read/write procedure is illustrated in Figure 6-2. During read/write operations, a 9-bit data stream is shifted into the shift register on every rising edge of the clock. The bit sequence is D/C, followed by D7 to D0. The first bit (D/C) determines whether the following byte is a command or data: when D/C = 0, the byte is interpreted as a command; when D/C = 1, the byte is interpreted as data. Table 6-3 shows the write procedure in 3-wire SPI.

Table 6-3 : Control pins status of 3-wire SPI

Function	SCL pin	SDA pin	D/C pin	CSB pin
Write command	↑	Command bit	Tie LOW	L
Read/Write data	↑	Data bit	Tie LOW	L

Note:

- (1) L is connected to GND and H is connected to VDDIO
- (2) ↑ stands for rising edge of signal

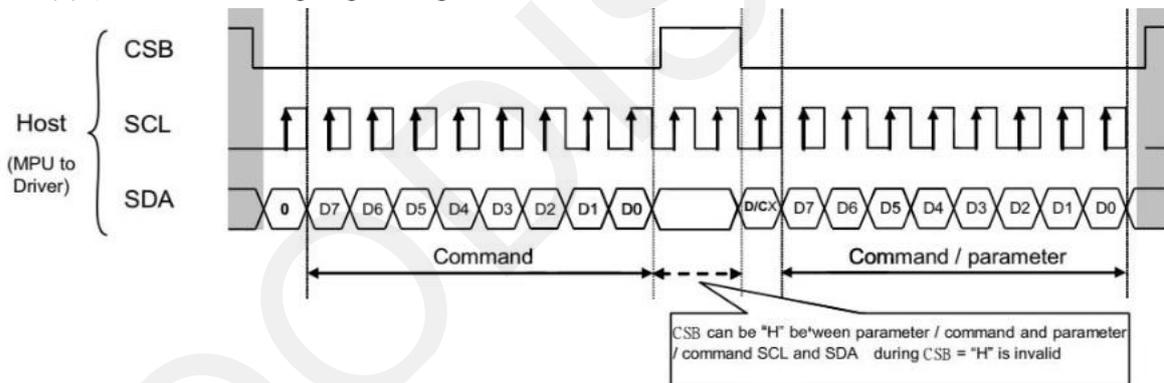


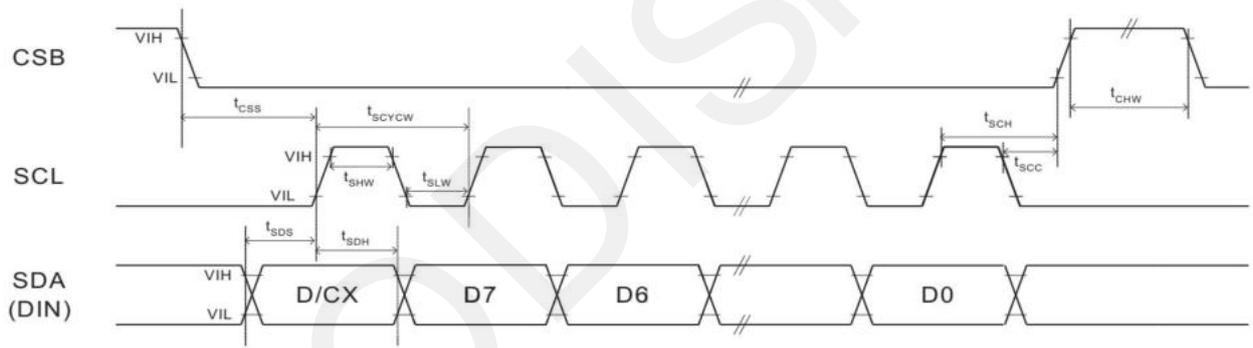
Figure 6-2: Read/Write procedure in 3-wire SPI mode

6.3.4 Interface Timing

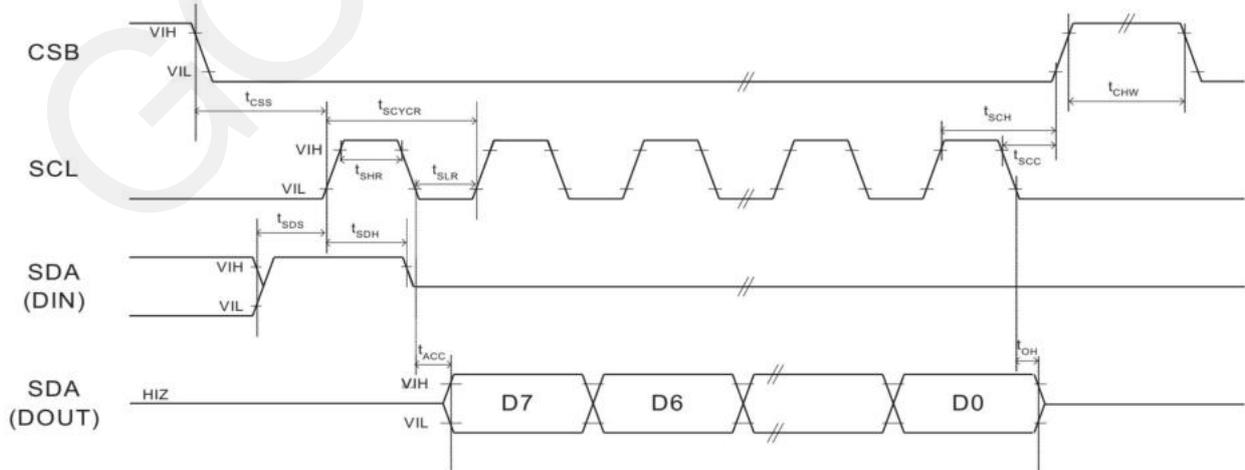
The following specifications apply for: VDDIO - GND = 2.3V to 3.6V, TOPR = 25°C, CL=20pF

Symbol	Parameter	Min	Typ	Max	Unit
t _{CSS}	CSB select setup time	60			ns
t _{SCH}	CSB select hold time	65			ns
t _{SCC}	CSB deselect setup time	25			ns
t _{CHW}	CSB deselect hold time	100			ns
t _{SCYCW}	Serial clock cycle (Write)	50			ns
t _{SHW}	SCL "H" pulse width (Write)	25			ns
t _{SLW}	SCL "L" pulse width (Write)	25			ns
t _{SCYCL}	Serial clock cycle (Read)	400			ns
t _{SHR}	SCL "H" pulse width (Read)	180			ns
t _{SLR}	SCL "L" pulse width (Read)	180			ns
t _{SDS}	Data setup time	30			ns
t _{SDH}	Data hold time	30			ns
t _{DCS}	DC setup time	40			ns
t _{DCH}	DC hold time	40			ns
t _{ACC}	Access time			100	ns
t _{OH}	Output disable time	15			ns

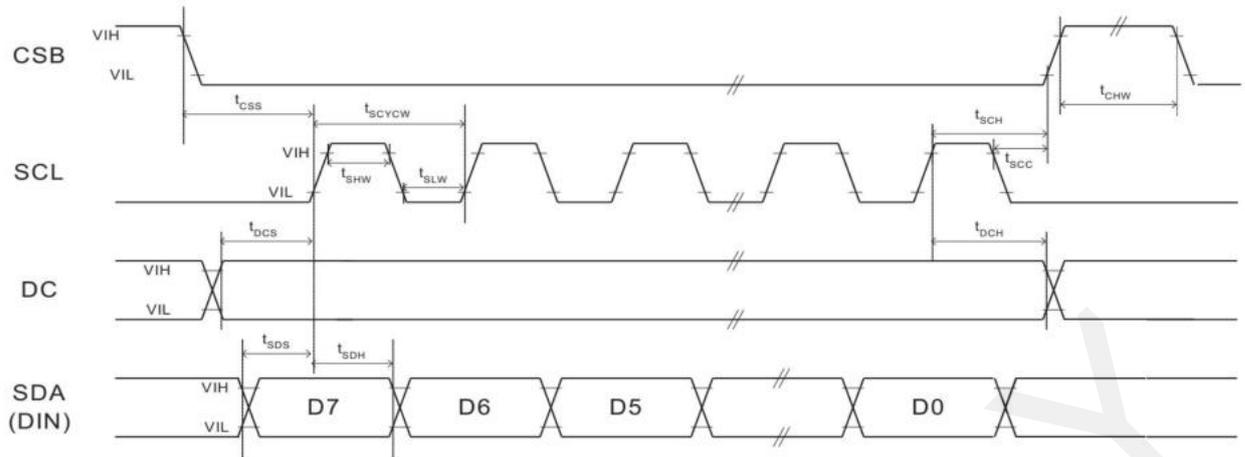
Note: All timings are based on 20% to 80% of VDDIO-GND



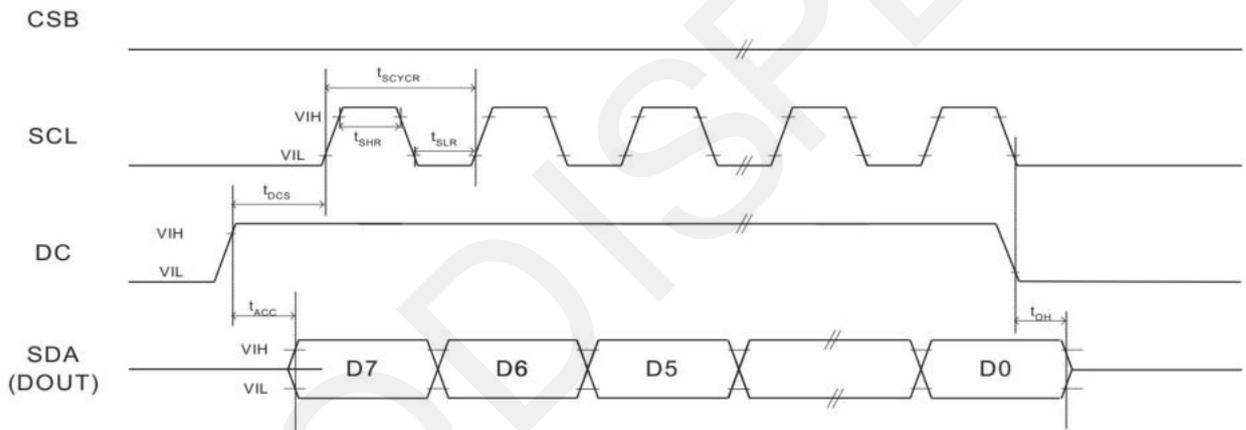
3-wire SPI characteristics (write mode)



3-wire SPI characteristics (read mode)



4-wire SPI characteristics (write mode)



4-wire SPI characteristics (read mode)

7. Command Table

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	0	00	0	0	0	0	0	0	0	0	PSR	Panel Setting Register
0	1		A ₇	A ₆	A ₅	0	A ₃	A ₂	A ₁	A ₀		A[7:0] = 2Fh [POR] B[7:0] = 09h [POR]
												A[7:6] ~ RES[1:0] Display Resolution setting (source x gate) 00b: 960 x 680 (Default) 01b: 960 x 672 10b: 960 x 640 11b: 880 x 528 *Remark: Inactive Gate outputs will be VGL for DRF and AMV. Inactive Source outputs will follow VCOM LUT output for DRF A[5] ~ B_mode Blanking Mode for voltage switching, the duration setting follow CDI. 0: Mode A Blanking time only for ACVCOM. 1: Mode B (Default) Blanking time for ACVCOM or switch mode of source power. A[3] ~ UD Gate Scan Direction: 0: Scan down. First line to Last line: Gn-1 ... G0 1: Scan up. (Default) First line to Last line: G0 ... Gn-1 A[2] ~ SHL Source Shift Direction: 0: Shift left. First data to Last data: Sn-1 ... S0 1: Shift right. (Default) First data to Last data: S0 ... Sn-1 A[1] ~ SHD_N Booster and Regulator Switch: 0: PON / POF command will not execute 1: PON / POF command will execute (Default) A[0] ~ RST_N Soft Reset: 0: The controller is reset. Reset all registers to their default value. Driver all function will be disabled. 1: Normal operation (Default). BUSY_N signal will become "0" until Soft reset is finished.
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		B[7] ~ LUT_EN

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
												0: During reset, auto load LUT from OTP if it is valid. When PON/DRF, analog setting will follow the content of OTP. (Default) 1: During reset, no action to load LUT from OTP. When PON/DRF, analog setting will follow the content of MCU B[6:5] ~ FOPT[1:0] FOPT function 00b: NO effect. Scan 1 frame after waveform finished (Default) 01b: Will scan 1 frame same as last output (of LUT) after waveform finished. 10b: Will scan 1 frame with Floating output after waveform finished. 11b: No Scan after waveform finished (Power off floating) B[4] ~ VCMZ VCOM Hi-Z option 0: NO effect. (default) 1: VCOM is always floating. B[3] ~ TS_AUTO Temperature Sensor auto option 0: NO effect. 1: Before loading OTP, Temperature Sensor will be activated automatically one time. (default) B[2] ~ TIEG VGL power off option 0: NO effect. (default) 1: After power off booster, VGL will be tied to GND. B[1] ~ NORG VCOM display end GND option 0: NO effect. (default) 1: After refreshing display, VCOM is tied to GND before power off B[0] ~ VC_LUTZ VCOM display end floating option 0: NO effect. 1: After refreshing display, the output of VCOM is set to floating automatically (default)

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	0	01	0	0	0	0	0	0	0	1	PWR	Power setting Register A[5:0] = 07h [POR] B[7:0] = F0h [POR] C[6:0] = 00h [POR] D[6:0] = 00h [POR] E[6:0] = 00h [POR] F[6:0] = 00h [POR]
0	1		0	0	0	0	0	A ₂	A ₁	A ₀		A[2] ~ VSC_EN Source LV power selection: 0: External source power for VSH2 pin. 1: Internal DCDC function for generate source power. (default) A[1] ~ VS_EN Source LV power selection; 0: External source power for VSH1 and VSL pin. 1: Internal DCDC function for generate source power. (default) A[0] ~ VG_EN Gate power selection: 0: External gate power for VGH and VGL pin. 1: Internal DCDC function for generate gate power. (default)

0	1		1	1	1	1	0	0	B ₁	B ₀	<p>B[1:0] ~ VGPN [1:0] Internal VGH / VGL Voltage Level Selection:</p> <table border="1"> <thead> <tr> <th>VGPN [1:0]</th> <th>Gate Voltage Level</th> </tr> </thead> <tbody> <tr> <td>00</td> <td>VGH=20V, VGL=-20V (Default) VSH1=15V, VSL=-15V</td> </tr> <tr> <td>01</td> <td>VGH=17V, VGL=-17V VSH1=15V, VSL=-15V</td> </tr> <tr> <td>10</td> <td>VGH=15V, VGL=-15V VSH1=13V, VSL=-13V</td> </tr> <tr> <td>11</td> <td>Reserved.</td> </tr> </tbody> </table>	VGPN [1:0]	Gate Voltage Level	00	VGH=20V, VGL=-20V (Default) VSH1=15V, VSL=-15V	01	VGH=17V, VGL=-17V VSH1=15V, VSL=-15V	10	VGH=15V, VGL=-15V VSH1=13V, VSL=-13V	11	Reserved.								
VGPN [1:0]	Gate Voltage Level																												
00	VGH=20V, VGL=-20V (Default) VSH1=15V, VSL=-15V																												
01	VGH=17V, VGL=-17V VSH1=15V, VSL=-15V																												
10	VGH=15V, VGL=-15V VSH1=13V, VSL=-13V																												
11	Reserved.																												
0	1		0	C ₆	C ₅	C ₄	C ₃	C ₂	C ₁	C ₀	<p>C[6:0] ~ VSPL [6:0] Internal Source Voltage Level Selection for VSH2@Mode0:</p> <table border="1"> <thead> <tr> <th>VSPL[6:0]</th> <th>Voltage Level</th> </tr> </thead> <tbody> <tr> <td>00h</td> <td>3.0V (default)</td> </tr> <tr> <td>02h</td> <td>3.2V</td> </tr> <tr> <td>04h</td> <td>3.4V</td> </tr> <tr> <td>06h</td> <td>3.6V</td> </tr> <tr> <td>:</td> <td>:</td> </tr> <tr> <td>76h</td> <td>14.8V</td> </tr> <tr> <td>78h</td> <td>15.0V</td> </tr> <tr> <td>Other</td> <td>Reserved</td> </tr> </tbody> </table>	VSPL[6:0]	Voltage Level	00h	3.0V (default)	02h	3.2V	04h	3.4V	06h	3.6V	:	:	76h	14.8V	78h	15.0V	Other	Reserved
VSPL[6:0]	Voltage Level																												
00h	3.0V (default)																												
02h	3.2V																												
04h	3.4V																												
06h	3.6V																												
:	:																												
76h	14.8V																												
78h	15.0V																												
Other	Reserved																												
0	1		0	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀	<p>D[6:0] ~ VSNL[6:0] Internal Source Voltage Level Selection for VSL@Mode1:</p> <table border="1"> <thead> <tr> <th>VSNL[6:0]</th> <th>Voltage Level</th> </tr> </thead> <tbody> <tr> <td>00h</td> <td>-3.0V (default)</td> </tr> <tr> <td>02h</td> <td>-3.2V</td> </tr> <tr> <td>04h</td> <td>-3.4V</td> </tr> <tr> <td>06h</td> <td>-3.6V</td> </tr> <tr> <td>:</td> <td>:</td> </tr> <tr> <td>76h</td> <td>-14.8V</td> </tr> <tr> <td>78h</td> <td>-15.0V</td> </tr> <tr> <td>Other</td> <td>Reserved</td> </tr> </tbody> </table>	VSNL[6:0]	Voltage Level	00h	-3.0V (default)	02h	-3.2V	04h	-3.4V	06h	-3.6V	:	:	76h	-14.8V	78h	-15.0V	Other	Reserved
VSNL[6:0]	Voltage Level																												
00h	-3.0V (default)																												
02h	-3.2V																												
04h	-3.4V																												
06h	-3.6V																												
:	:																												
76h	-14.8V																												
78h	-15.0V																												
Other	Reserved																												

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																		
0	1		0	E ₆	E ₅	E ₄	E ₃	E ₂	E ₁	E ₀		<p>E[6:0] ~ VSPL2[6:0] Internal Source Voltage Level Selection for VSH1@Mode1:</p> <table border="1"> <thead> <tr> <th>VSPL2[6:0]</th> <th>Voltage Level</th> </tr> </thead> <tbody> <tr> <td>00h</td> <td>3.0V (default)</td> </tr> <tr> <td>02h</td> <td>3.2V</td> </tr> <tr> <td>04h</td> <td>3.4V</td> </tr> <tr> <td>06h</td> <td>3.6V</td> </tr> <tr> <td>:</td> <td>:</td> </tr> <tr> <td>76h</td> <td>14.8V</td> </tr> <tr> <td>78h</td> <td>15.0V</td> </tr> <tr> <td>Other</td> <td>Reserved</td> </tr> </tbody> </table>	VSPL2[6:0]	Voltage Level	00h	3.0V (default)	02h	3.2V	04h	3.4V	06h	3.6V	:	:	76h	14.8V	78h	15.0V	Other	Reserved
VSPL2[6:0]	Voltage Level																													
00h	3.0V (default)																													
02h	3.2V																													
04h	3.4V																													
06h	3.6V																													
:	:																													
76h	14.8V																													
78h	15.0V																													
Other	Reserved																													
0	1		0	F ₆	F ₅	F ₄	F ₃	F ₂	F ₁	F ₀		<p>F[6:0] ~ VSNL2[6:0] Internal Source Voltage Level Selection for VSH2@Mode1:</p> <table border="1"> <thead> <tr> <th>VSNL2[6:0]</th> <th>Voltage Level</th> </tr> </thead> <tbody> <tr> <td>00h</td> <td>3.0V (default)</td> </tr> <tr> <td>02h</td> <td>3.2V</td> </tr> <tr> <td>04h</td> <td>3.4V</td> </tr> <tr> <td>06h</td> <td>3.6V</td> </tr> <tr> <td>:</td> <td>:</td> </tr> <tr> <td>76h</td> <td>14.8V</td> </tr> <tr> <td>78h</td> <td>15.0V</td> </tr> <tr> <td>Other</td> <td>Reserved</td> </tr> </tbody> </table>	VSNL2[6:0]	Voltage Level	00h	3.0V (default)	02h	3.2V	04h	3.4V	06h	3.6V	:	:	76h	14.8V	78h	15.0V	Other	Reserved
VSNL2[6:0]	Voltage Level																													
00h	3.0V (default)																													
02h	3.2V																													
04h	3.4V																													
06h	3.6V																													
:	:																													
76h	14.8V																													
78h	15.0V																													
Other	Reserved																													
0	0	02	0	0	0	0	0	0	1	0	POF	Power OFF Command Register																		
0	1		0	0	0	0	0	0	0	0		<p>After power off command, driver will power off based on the Power OFF Sequence. BUSY_N will output low during operation. The Power OFF command will turn off DCDC, source driver, gate driver, VCOM driver, temperature sensor, but register and SRAM data will keep until VDD off. SD output will base on previous condition. *Remark: POF works at PON only</p>																		

0	0	03	0	0	0	0	0	0	0	1	1	POFS	Power on/off Sequence Setting Register A[7:0] = 00h [POR]
0	1		0	0	A ₅	A ₄	0	0	A ₁	A ₀			A[5:4] ~ T_VDPG_OFF[1:0] Power off delay from VGL to VGH 00b: 20ms (default) 01b: 40ms 10b: 60ms 11b: 80ms A[1:0] ~ T_VDS_OFF[1:0] Power off delay from VSHX/VSL to VGH 00b: 20ms (default) 01b: 40ms 10b: 60ms 11b : 80ms

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description
0	0	04	0	0	0	0	0	1	0	0	PON	Power ON Command Register After the Power ON command, driver will power on based on the Power ON Sequence. BUSY_N will output low during operation. * Remark: PON Include booster on, VSH1/VSH2/VSL regulator on With default BTST, timing is >80ms

0	0	06	0	0	0	0	0	1	1	0	BTST	VGH Booster Soft Start Setting Register (for VGH) A[6:0] = 0Fh [POR] B[6:0] = 8Bh [POR] C[6:0] = 93h [POR] D[6:0] = A3h [POR]																																				
0	1		0	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		A[6:4] ~ VGHSSC_ONT [2:0] VGH booster maximum MOSFET ON time (reserved) A[6:4] = 000 (Default)																																				
0	1		1	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀		A[3:2] ~ T_VGHSSA [1:0] = 11 (Default) VGH booster soft start Phase A duration																																				
0	1		1	C ₆	C ₅	C ₄	C ₃	C ₂	C ₁	C ₀		A[1:0] ~ T_VGHSSB [1:0] = 11 (Default) VGH booster soft start Phase B duration																																				
0	1		1	D ₆	D ₅	D ₄	D ₃	D ₂	D ₁	D ₀		VGH booster soft start Phase C duration																																				
<table border="1"> <thead> <tr> <th colspan="4">Soft Start Phase Period (ms)</th> </tr> </thead> <tbody> <tr><td>00</td><td>10</td><td></td><td></td></tr> <tr><td>01</td><td>20</td><td></td><td></td></tr> <tr><td>10</td><td>30</td><td></td><td></td></tr> <tr><td>11</td><td>40</td><td></td><td></td></tr> </tbody> </table>													Soft Start Phase Period (ms)				00	10			01	20			10	30			11	40																		
Soft Start Phase Period (ms)																																																
00	10																																															
01	20																																															
10	30																																															
11	40																																															
<table border="1"> <thead> <tr> <th colspan="4">Driving Strength</th> </tr> </thead> <tbody> <tr><td>000</td><td>0</td><td>100</td><td>(reserved)</td></tr> <tr><td>001</td><td>1</td><td>101</td><td>(reserved)</td></tr> <tr><td>010</td><td>2</td><td>110</td><td>(reserved)</td></tr> <tr><td>011</td><td>3(strongest)</td><td>111</td><td>(reserved)</td></tr> </tbody> </table>													Driving Strength				000	0	100	(reserved)	001	1	101	(reserved)	010	2	110	(reserved)	011	3(strongest)	111	(reserved)																
Driving Strength																																																
000	0	100	(reserved)																																													
001	1	101	(reserved)																																													
010	2	110	(reserved)																																													
011	3(strongest)	111	(reserved)																																													
<table border="1"> <thead> <tr> <th colspan="4">Minimum OFF Time (setting)</th> </tr> </thead> <tbody> <tr><td>0000</td><td>OFFH0</td><td>1000</td><td>OFFH8</td></tr> <tr><td>0001</td><td>OFFH1</td><td>1001</td><td>OFFH9</td></tr> <tr><td>0010</td><td>OFFH2</td><td>1010</td><td>OFFHA</td></tr> <tr><td>0011</td><td>OFFH3</td><td>1011</td><td>OFFHB</td></tr> <tr><td>0100</td><td>OFFH4</td><td>1100</td><td>OFFHC</td></tr> <tr><td>0101</td><td>OFFH5</td><td>1101</td><td>OFFHD</td></tr> <tr><td>0110</td><td>OFFH6</td><td>1110</td><td>OFFHE</td></tr> <tr><td>0111</td><td>OFFH7</td><td>1111</td><td>OFFHF</td></tr> </tbody> </table>													Minimum OFF Time (setting)				0000	OFFH0	1000	OFFH8	0001	OFFH1	1001	OFFH9	0010	OFFH2	1010	OFFHA	0011	OFFH3	1011	OFFHB	0100	OFFH4	1100	OFFHC	0101	OFFH5	1101	OFFHD	0110	OFFH6	1110	OFFHE	0111	OFFH7	1111	OFFHF
Minimum OFF Time (setting)																																																
0000	OFFH0	1000	OFFH8																																													
0001	OFFH1	1001	OFFH9																																													
0010	OFFH2	1010	OFFHA																																													
0011	OFFH3	1011	OFFHB																																													
0100	OFFH4	1100	OFFHC																																													
0101	OFFH5	1101	OFFHD																																													
0110	OFFH6	1110	OFFHE																																													
0111	OFFH7	1111	OFFHF																																													
B[6:4] ~ VGHSSA_DRV [2:0], = 000 (Default) VGH Phase A Driving Strength C[6:4] ~ VGHSSB_DRV [2:0], = 001 (Default) VGH Phase B Driving Strength D[6:4] ~ VGHSSC_DRV [2:0] = 010 (Default) VGH Phase C Driving Strength																																																
B[3:0] ~ VGHSSA_OFFT [3:0], = 1011 (Default) VGH Phase A Minimum OFF Time C[3:0] ~ VGHSSB_OFFT [3:0], = 0011 (Default) VGH Phase B Minimum OFF Time D[3:0] ~ VGHSSC_OFFT [3:0], = 0011 (Default) VGH Phase C Minimum OFF Time																																																

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description	
0	0	07	0	0	0	0	0	1	1	1	DSLTP	Deep Sleep Register	
0	1		1	0	1	0	0	1	0	1		This command makes the chip enter the deep-sleep mode. The deep sleep mode could return to stand-by mode by hardware reset assertion. The only one parameter is a check code, the command would be executed if check code is A5h.	
0	0	10	0	0	0	1	0	0	0	0	DTM	Data Start transmission Register	
2 bit per pixel													
0	1		KPixel1 [1:0]	KPixel2 [1:0]	KPixel3 [1:0]	KPixel4 [1:0]						This command indicates that user starts to transmit data. Then write to SRAM. While complete data transmission, user must send a Data Refresh command (R12H). Then the chip will start to send data/VCOM for panel.	
:			...										
0	1		KPixel (4M-3) [1:0]	KPixel (4M-2) [1:0]	KPixel (4M-1) [1:0]	KPixel (4M) [1:0]						KPixel[1:0] Source Driver Output	
											DDX=1 (Default)	DDX=0	
											00b	Gray 0	Gray 3
											01b	Gray 1	Gray 2
											10b	Gray 2	Gray 1
											11b	Gray 3	Gray 0
												After issue this command, the host must send at least 1 byte data to the device.	
0	0	12	0	0	0	1	0	0	1	0	DRF	Display Refresh Command Register	
0	1		0	0	0	0	0	0	0	0		After this command is issued, driver will refresh display (data/VCOM) according to SRAM data and LUT. BUSY_N will output low during operation.	
0	0	17	0	0	0	1	0	1	1	1	AUTO	Auto Sequence Register	
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		This command makes the chip enter the auto sequence Single-chip application ONLY. Auto Sequence Option 0xA5: Start Auto Sequence (PON > DRF > POF) 0xA7: Start Auto Sequence (PON > DRF > POF > DSLTP). Others: No effect BUSY_N signal will become "0" until Auto Sequence is finished.	
0	0	30	0	0	1	1	0	0	0	0	PLL	Frame Rate Control register	
0	1		0	0	0	0	0	A ₂	A ₁	A ₀		The command controls the clock frequency. A[3:0] = 2h [POR] A[3]: Dynamic Frame Rate 0: Disable (Default) 1: Enable A[2:0] ~ FR[2:0] It supports the following frame rates. Frame Rate Selection, Frame rate for Gate/Source switching that exclude the blanking time defined in CDI.	
											FR[2:0]	Frame Rate Selection	
											000	12.5Hz	
											001	25Hz	
											010	50Hz (Default)	
											011	65Hz	
											100	75Hz	
											101	85Hz	

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																																																									
0	0	40	0	1	0	0	0	0	0	0	TSC	Temperature Sensor Command Register																																																									
1	1		A7	A6	A5	A4	A3	A2	A1	A0		This command enables internal temperature sensor. BUSY_N will output low during operation. Then the temperature value can be read in 1degC step A[7:0] ~ TS [7:0] <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>TS [7:0]</th> <th>Return Value(degC)</th> </tr> </thead> <tbody> <tr><td>E7h</td><td>-25</td></tr> <tr><td>...</td><td>...</td></tr> <tr><td>FFh</td><td>-1</td></tr> <tr><td>00h</td><td>0</td></tr> <tr><td>01h</td><td>1</td></tr> <tr><td>...</td><td>...</td></tr> <tr><td>19h</td><td>25</td></tr> <tr><td>...</td><td>...</td></tr> <tr><td>31h</td><td>49</td></tr> <tr><td>32h</td><td>50</td></tr> </tbody> </table>	TS [7:0]	Return Value(degC)	E7h	-25	FFh	-1	00h	0	01h	1	19h	25	31h	49	32h	50																																			
TS [7:0]	Return Value(degC)																																																																				
E7h	-25																																																																				
...	...																																																																				
FFh	-1																																																																				
00h	0																																																																				
01h	1																																																																				
...	...																																																																				
19h	25																																																																				
...	...																																																																				
31h	49																																																																				
32h	50																																																																				
0	0	41	0	1	0	0	0	0	0	1	TSE	Temperature Sensor Enable Register																																																									
0	1		0	0	0	0	A3	A2	A1	0		This command selects Temperature offset A[7:0] = 00h [POR] A[3:0] ~ TO[3:1] , Temperature offset: <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>TO[3:1]</th> <th>Calculation</th> <th>TO[3:1]</th> <th>Calculation</th> </tr> </thead> <tbody> <tr><td>000</td><td>+0</td><td>100</td><td>-4</td></tr> <tr><td>001</td><td>+1</td><td>101</td><td>-3</td></tr> <tr><td>010</td><td>+2</td><td>110</td><td>-2</td></tr> <tr><td>011</td><td>+3</td><td>111</td><td>-1</td></tr> </tbody> </table>	TO[3:1]	Calculation	TO[3:1]	Calculation	000	+0	100	-4	001	+1	101	-3	010	+2	110	-2	011	+3	111	-1																																					
TO[3:1]	Calculation	TO[3:1]	Calculation																																																																		
000	+0	100	-4																																																																		
001	+1	101	-3																																																																		
010	+2	110	-2																																																																		
011	+3	111	-1																																																																		
0	0	50	0	1	0	1	0	0	0	0	CDI	VCOM and DATA interval setting Register																																																									
0	1		A7	A6	A5	A4	A3	A2	A1	A0		This command indicates the Border Output Selection and the interval between Vcom and data output A[7:0] = 97h [POR] A[7:5]~VBD [2:0] Border Output Selection: <table border="1" style="margin-left: 20px;"> <thead> <tr> <th></th> <th>DDX=1</th> <th>DDX=0</th> </tr> </thead> <tbody> <tr> <th>VBD[2:0]</th> <th>LUT (Default)</th> <th>LUT</th> </tr> <tr><td>000</td><td>Gray 0</td><td>HIZ</td></tr> <tr><td>001</td><td>Gray 1</td><td>Gray 3</td></tr> <tr><td>010</td><td>Gray 2</td><td>Gray 2</td></tr> <tr><td>011</td><td>Gray 3</td><td>Gray 1</td></tr> <tr><td>100</td><td>HIZ(Default)</td><td>Gray 0</td></tr> </tbody> </table> A[4]: DDX Data Polarity for Pixel Data (See DTM command) 0: Invert 1: Non-invert (Default) A[3:0] ~ CDI[3:0] Gate and source blanking time (No gate source scanning) <table border="1" style="margin-left: 20px;"> <thead> <tr> <th>CDI [3:0]</th> <th>Interval (ms)</th> <th>CDI [3:0]</th> <th>Interval (ms)</th> </tr> </thead> <tbody> <tr><td>0h</td><td>2</td><td>8h</td><td>40</td></tr> <tr><td>1h</td><td>4</td><td>9h</td><td>60</td></tr> <tr><td>2h</td><td>8</td><td>Ah</td><td>80</td></tr> <tr><td>3h</td><td>12</td><td>Bh</td><td>100</td></tr> <tr><td>4h</td><td>14</td><td>Ch</td><td>120</td></tr> <tr><td>5h</td><td>16</td><td>Dh</td><td>140</td></tr> <tr><td>6h</td><td>18</td><td>Eh</td><td>160</td></tr> <tr><td>7h</td><td>20 (Default)</td><td>Fh</td><td>Reserved</td></tr> </tbody> </table> User needs to review CDI setting to have stable VCOM in application		DDX=1	DDX=0	VBD[2:0]	LUT (Default)	LUT	000	Gray 0	HIZ	001	Gray 1	Gray 3	010	Gray 2	Gray 2	011	Gray 3	Gray 1	100	HIZ(Default)	Gray 0	CDI [3:0]	Interval (ms)	CDI [3:0]	Interval (ms)	0h	2	8h	40	1h	4	9h	60	2h	8	Ah	80	3h	12	Bh	100	4h	14	Ch	120	5h	16	Dh	140	6h	18	Eh	160	7h	20 (Default)	Fh	Reserved
	DDX=1	DDX=0																																																																			
VBD[2:0]	LUT (Default)	LUT																																																																			
000	Gray 0	HIZ																																																																			
001	Gray 1	Gray 3																																																																			
010	Gray 2	Gray 2																																																																			
011	Gray 3	Gray 1																																																																			
100	HIZ(Default)	Gray 0																																																																			
CDI [3:0]	Interval (ms)	CDI [3:0]	Interval (ms)																																																																		
0h	2	8h	40																																																																		
1h	4	9h	60																																																																		
2h	8	Ah	80																																																																		
3h	12	Bh	100																																																																		
4h	14	Ch	120																																																																		
5h	16	Dh	140																																																																		
6h	18	Eh	160																																																																		
7h	20 (Default)	Fh	Reserved																																																																		

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																
0	0	51	0	1	0	1	0	0	0	1	LPD	Lower Power Detection Register																
1	1		0	0	0	0	0	0	0	A ₀		BUSY_N will output low during operation. Then the LPD status can be read. A[0] ~ LPD status 0: Low power input (VDD<2.5V, selected by LVD_SEL[1:0] in command LVSEL) 1: Normal (default)																
0	0	61	0	1	1	0	0	0	0	1	TRES	Resolution setting Register A[9:0] = 3C0h [POR] B[9:0] = 2A8h [POR]																
0	1		0	0	0	0	0	0	A ₉	A ₈		This command defines alternative resolution. A[9:0] ~ HRES[9:0] Horizontal Display Resolution Remark: Horizontal resolution should be 4-multiple. B[9:0] ~ VRES[9:0] Vertical Display Resolution e.g. HRES= 3C0h, VRES= 2A8h																
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																		
0	1		0	0	0	0	0	0	B ₉	B ₈																		
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀																		
												<table border="1"> <thead> <tr> <th>UD,SHL</th> <th>Source and gate sequence</th> </tr> </thead> <tbody> <tr> <td>00</td> <td>S959,G679 to S0,G0</td> </tr> <tr> <td>01</td> <td>S0, G679 to S959,G0</td> </tr> <tr> <td>10</td> <td>S959,G0 to S0, G679</td> </tr> <tr> <td>11</td> <td>S0,G0 to S959, G679</td> </tr> </tbody> </table> <p>Remark: 1) Both PSR.RES & TRES command can set panel resolution. Priority will be given to the last received PSR or TRES command. 2) VRES[9:0] >= 420</p>	UD,SHL	Source and gate sequence	00	S959,G679 to S0,G0	01	S0, G679 to S959,G0	10	S959,G0 to S0, G679	11	S0,G0 to S959, G679						
UD,SHL	Source and gate sequence																											
00	S959,G679 to S0,G0																											
01	S0, G679 to S959,G0																											
10	S959,G0 to S0, G679																											
11	S0,G0 to S959, G679																											
0	0	65	0	1	1	0	0	1	0	1	GSST	Gate/Source Start Setting Register A[9:0] = 0x000h [POR] B[9:0] = 0x000h [POR]																
0	1								A ₉	A ₈		A[9:0] ~ S_start[9:0] First valid source output channel setting																
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																		
0	1								B ₉	B ₈																		
0	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀																		
												<table border="1"> <thead> <tr> <th>S_start [9:0]</th> <th>First valid source output</th> </tr> </thead> <tbody> <tr> <td>000h</td> <td>S0 (Default)</td> </tr> <tr> <td>004h</td> <td>S4</td> </tr> <tr> <td>008h</td> <td>S8</td> </tr> <tr> <td>...</td> <td>...</td> </tr> <tr> <td>3B8h</td> <td>S952</td> </tr> <tr> <td>3BCh</td> <td>S956</td> </tr> <tr> <td>Other</td> <td>Reserved</td> </tr> </tbody> </table> <p>B[9:0] ~ G_start[9:0] First valid gate output channel setting</p> <p>GSST and TRES can define the display window from target source and gate start and end line. GD: First G active = G16, G_start[9:0]=16. Last G active = G543, VRES[9:0]=528. SD: First S active = S8, S_start[9:0]=8. Last S active = S887, HRES[9:0]=880.</p> <p>Remark: G_start+VRES< 680, S_start+HRES< 960.</p>	S_start [9:0]	First valid source output	000h	S0 (Default)	004h	S4	008h	S8	3B8h	S952	3BCh	S956	Other	Reserved
S_start [9:0]	First valid source output																											
000h	S0 (Default)																											
004h	S4																											
008h	S8																											
...	...																											
3B8h	S952																											
3BCh	S956																											
Other	Reserved																											

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																						
0	0	70	0	1	1	1	0	0	0	0	REV	Chip Revision Register The command is to read the ID A[7:0] = 07h [POR] B[7:0] = 01h [POR] C[7:0] = 01h [POR]																						
1	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																								
1	1		B ₇	B ₆	B ₅	B ₄	B ₃	B ₂	B ₁	B ₀																								
1	1		C ₇	C ₆	C ₅	C ₄	C ₃	C ₂	C ₁	C ₀																								
0	0	80	1	0	0	0	0	0	0	0	AMV	Auto Measurement VCOM Register This command implements related VCOM sensing setting. A[7:0] = 00h [POR]																						
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	0	A ₀																								
<p>A[7:6] ~ P[1:0] Number of sensing Points 00: 2 (Default) 01: 4 10: 8 11: 16</p> <p>A[5:4] ~ AMVT[1:0] Auto Measure Vcom Time: Sensing Time 00: 5 sec. (Default) 01: 10 sec. 10: 15 sec. 11: 20 sec.</p> <p>A[3] ~ AMVX VCOM measurement Gate settings 0: Gate scan normally during VCOM measurement (Default) 1: All Gates ON during VCOM measurement</p> <p>A[2] ~ AMVS Source output of AMV: 0: Set Source output to 0V during Auto Measure VCOM period. (Default) 1: Set Source output to VSH_LV during Auto Measure VCOM period.</p> <p>A[0] ~ AMVE Auto Measure Vcom Enable (/Disable): 0: Disabled (Default) 1: Enabled BUSY_N will output low during operation.</p> <p>Note: AMV only can work while PON only</p>																																		
0	0	81	1	0	0	0	0	0	0	1	VV	Auto Measurement VCOM Register This command gets the Vcom value after AMV.																						
1	1		1	0	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀																								
<p>A[5:0] ~ VV[5:0]: Vcom read Value , valid range from -0.2V to -4.0V.</p> <table border="1"> <thead> <tr> <th>VV[5:0]</th> <th>Vcom read value</th> </tr> </thead> <tbody> <tr> <td>00h</td> <td>Reserved</td> </tr> <tr> <td>04h</td> <td>-0.2V</td> </tr> <tr> <td>08h</td> <td>-0.4V</td> </tr> <tr> <td>0Ch</td> <td>-0.6V</td> </tr> <tr> <td>10h</td> <td>-0.8V</td> </tr> <tr> <td>...</td> <td>...</td> </tr> <tr> <td>3Ch</td> <td>-3.0V</td> </tr> <tr> <td>...</td> <td>...</td> </tr> <tr> <td>50h</td> <td>-4.0V</td> </tr> <tr> <td>others</td> <td>Reserved</td> </tr> </tbody> </table>													VV[5:0]	Vcom read value	00h	Reserved	04h	-0.2V	08h	-0.4V	0Ch	-0.6V	10h	-0.8V	3Ch	-3.0V	50h	-4.0V	others	Reserved
VV[5:0]	Vcom read value																																	
00h	Reserved																																	
04h	-0.2V																																	
08h	-0.4V																																	
0Ch	-0.6V																																	
10h	-0.8V																																	
...	...																																	
3Ch	-3.0V																																	
...	...																																	
50h	-4.0V																																	
others	Reserved																																	

R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																						
0	0	82	1	0	0	0	0	0	1	0	VDCS	VCM_DC Setting Register This command sets VCOM_DC value. A[7:0] = 00h [POR]																						
0	1		A7	A6	A5	A4	A3	A2	0	0		A[7] ~ OTP_VCM Vcom follow VDCS after RESET. 0: Disable (Default), auto load from OTP if it is valid. 1: Enable, VCOM value from the VDCS[6:0] A[6:0] ~ VDCS[6:0]: VCOM DC Setting, 0.2V step from -0.2V to -4.0V.																						
												<table border="1"> <thead> <tr> <th>VDCS [6:0]</th> <th>VCOM_DC Setting</th> </tr> </thead> <tbody> <tr> <td>00h</td> <td>Reserved</td> </tr> <tr> <td>04h</td> <td>-0.2V</td> </tr> <tr> <td>08h</td> <td>-0.4V</td> </tr> <tr> <td>0Ch</td> <td>-0.6V</td> </tr> <tr> <td>10h</td> <td>-0.8V</td> </tr> <tr> <td>...</td> <td>...</td> </tr> <tr> <td>3Ch</td> <td>-3.0V</td> </tr> <tr> <td>...</td> <td>...</td> </tr> <tr> <td>50h</td> <td>-4.0V</td> </tr> <tr> <td>others</td> <td>Reserved</td> </tr> </tbody> </table>	VDCS [6:0]	VCOM_DC Setting	00h	Reserved	04h	-0.2V	08h	-0.4V	0Ch	-0.6V	10h	-0.8V	3Ch	-3.0V	50h	-4.0V	others	Reserved
VDCS [6:0]	VCOM_DC Setting																																	
00h	Reserved																																	
04h	-0.2V																																	
08h	-0.4V																																	
0Ch	-0.6V																																	
10h	-0.8V																																	
...	...																																	
3Ch	-3.0V																																	
...	...																																	
50h	-4.0V																																	
others	Reserved																																	
0	0	83	1	0	0	0	0	0	1	1	PTLW	Partial Window This command sets partial window address. A[9:0] = 000h [POR] B[9:0] = 3BFh [POR] C[9:0] = 000h [POR] D[9:0] = 2A7h [POR] E[7:0] = 00h [POR]																						
0			0	0	0	0	0	0	A9	A8																								
0	1		A7	A6	A5	A4	A3	A2	A1	A0																								
0	1		0	0	0	0	0	0	B9	B8																								
0	1		B7	B6	B5	B4	B3	B2	B1	B0																								
0	1		0	0	0	0	0	0	C9	C8																								
0	1		C7	C6	C5	C4	C3	C2	C1	C0		A[9:0] ~ HRST [9:0] Horizontal start address																						
0	1		0	0	0	0	0	0	D9	D8		B[9:0] ~ HRED [9:0] Horizontal end address																						
0	1		D7	D6	D5	D4	D3	D2	D1	D0		C[9:0] ~ VRST [9:0] Vertical start address																						
0	1		0	0	0	0	0	0	0	E0		D[9:0] ~ VRED [9:0] Vertical end address E[0] ~ PMODE 0: disable partial mode (Default) 1: enable partial mode Gate scan both inside and outside of the partial window Note: 1) HRST [9:0] <= HRED [9:0] 2) VRST [9:0] <= VRED [9:0]																						
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																						
0	0	90	1	0	0	1	0	0	0	0	PGM	Program Mode This command is to set OTP program mode After this command is issued, the chip would enter the program mode. After the programming procedure completed, a hardware reset is necessary for leave the program mode BUSY_N will output low when PGM mode is ready.																						

0	0	91	1	0	0	1	0	0	0	1	APG	Active Program This command is to execute OTP program After this command is issued, the chip would program the OTP. BUSY_N will output low during operation. Note: In PON mode with internal programming power.																																				
0	0	92	1	0	0	1	0	0	1	0	ROTP	Read OTP Data This command is to read the OTP content from SRAM. The 1 st byte read is dummy byte. The 2 nd byte read is the content of Address 0 in OTP The N+1 th byte read is the content of Address n in OTP After issue this command, the host must read at least 1 byte data from the device.																																				
1	1											1 st ~ dummy 2 nd ~ N+1th Parameter																																				
0	0	E0	1	1	1	0	0	0	1	1	CCSET	Cascade & External temperature input A[7:0] = 00h [POR]																																				
0	1		0	0	0	0	0	0	A ₁	A ₀		A[1] ~ TSFIX 0: Use Internal Temperature Sensor (Default) 1: Use command 0xE6 TS_SET [7:0] value A[0] ~ CSEIN, cascade mode enable 0: Disable 1: Enable																																				
0	0	E3	1	1	1	0	0	0	1	1	PWS	Power Saving Register This command is sets for saving power VCOM/Source power saving during display refresh period. A[7:0] = 65h [POR]																																				
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀		If the output voltage of VCOM/Source is from negative to positive or from positive to negative, the power saving mechanism will be activated. The active period width is defined by the following two parameters. A[7:4] = VCOM_W [3:0]																																				
												<table border="1"> <thead> <tr> <th>VCOM_W [3:0]</th><th>VCOM_power saving width. (time unit)</th><th>VCOM_W [3:0]</th><th>VCOM_power saving width. (time unit)</th></tr> </thead> <tbody> <tr><td>0</td><td>Reserved</td><td>8</td><td>8</td></tr> <tr><td>1</td><td>1</td><td>9</td><td>9</td></tr> <tr><td>2</td><td>2</td><td>10</td><td>10</td></tr> <tr><td>3</td><td>3</td><td>11</td><td>11</td></tr> <tr><td>4</td><td>4</td><td>12</td><td>12</td></tr> <tr><td>5</td><td>5</td><td>13</td><td>13</td></tr> <tr><td>6</td><td>6[Default]</td><td>14</td><td>14</td></tr> <tr><td>7</td><td>7</td><td>15</td><td>15</td></tr> </tbody> </table>	VCOM_W [3:0]	VCOM_power saving width. (time unit)	VCOM_W [3:0]	VCOM_power saving width. (time unit)	0	Reserved	8	8	1	1	9	9	2	2	10	10	3	3	11	11	4	4	12	12	5	5	13	13	6	6[Default]	14	14	7	7	15	15
VCOM_W [3:0]	VCOM_power saving width. (time unit)	VCOM_W [3:0]	VCOM_power saving width. (time unit)																																													
0	Reserved	8	8																																													
1	1	9	9																																													
2	2	10	10																																													
3	3	11	11																																													
4	4	12	12																																													
5	5	13	13																																													
6	6[Default]	14	14																																													
7	7	15	15																																													
R/W#	D/C#	Hex	D7	D6	D5	D4	D3	D2	D1	D0	Command	Description																																				
												<table border="1"> <thead> <tr> <th>SD_W [3:0]</th><th>Source power saving width[us]</th><th>SD_W [3:0]</th><th>Source power saving width [us]</th></tr> </thead> <tbody> <tr><td>0</td><td>Reserved</td><td>8</td><td>4</td></tr> <tr><td>1</td><td>0.5</td><td>9</td><td>4.5</td></tr> <tr><td>2</td><td>1</td><td>10</td><td>5</td></tr> <tr><td>3</td><td>1.5</td><td>11</td><td>5.5</td></tr> <tr><td>4</td><td>2</td><td>12</td><td>6</td></tr> <tr><td>5</td><td>2.5[Default]</td><td>13</td><td>6.5</td></tr> <tr><td>6</td><td>3</td><td>14</td><td>7</td></tr> <tr><td>7</td><td>3.5</td><td>15</td><td>7.5</td></tr> </tbody> </table> <p>Remark: VCOM_W setting < CDI setting SD_W setting < S2G setting</p>	SD_W [3:0]	Source power saving width[us]	SD_W [3:0]	Source power saving width [us]	0	Reserved	8	4	1	0.5	9	4.5	2	1	10	5	3	1.5	11	5.5	4	2	12	6	5	2.5[Default]	13	6.5	6	3	14	7	7	3.5	15	7.5
SD_W [3:0]	Source power saving width[us]	SD_W [3:0]	Source power saving width [us]																																													
0	Reserved	8	4																																													
1	0.5	9	4.5																																													
2	1	10	5																																													
3	1.5	11	5.5																																													
4	2	12	6																																													
5	2.5[Default]	13	6.5																																													
6	3	14	7																																													
7	3.5	15	7.5																																													

0	0	E4	1	1	1	0	0	1	0	0	LVSEL	LVD Voltage Select Register This command is sets for low power detect level power A[1:0] = 03h [POR]																						
0	1		0	0	0	0	0	0	A ₁	A ₀			A[1:0] ~ LVD_SEL[1:0] Low power detection threshold 00: 2.2V 01: 2.3V 10: 2.4V 11 : 2.5V (Default)																					
0	0	E6	1	1	1	1	0	1	1	0	TS_SET	Manual input temperature value This command is to force the TS value A[7:0] = 00h [POR]																						
0	1		A ₇	A ₆	A ₅	A ₄	A ₃	A ₂	A ₁	A ₀			A[7:0] ~ TS_SET[7:0] When TSFIX=1, Temperature value will be set by TS_SET[7:0]. Format of the temperature value is 8-bit binary value and it is 1degC per step.																					
												<table border="1"> <thead> <tr> <th>TS_SET[7:0]</th><th>Force the TS Value(degC)</th></tr> </thead> <tbody> <tr> <td>E7h</td><td>-25</td></tr> <tr> <td>...</td><td>...</td></tr> <tr> <td>FFh</td><td>-1</td></tr> <tr> <td>00h</td><td>0</td></tr> <tr> <td>01h</td><td>1</td></tr> <tr> <td>...</td><td>...</td></tr> <tr> <td>19h</td><td>25</td></tr> <tr> <td>...</td><td>...</td></tr> <tr> <td>31h</td><td>49</td></tr> <tr> <td>32h</td><td>50</td></tr> </tbody> </table>	TS_SET[7:0]	Force the TS Value(degC)	E7h	-25	FFh	-1	00h	0	01h	1	19h	25	31h	49	32h	50
TS_SET[7:0]	Force the TS Value(degC)																																	
E7h	-25																																	
...	...																																	
FFh	-1																																	
00h	0																																	
01h	1																																	
...	...																																	
19h	25																																	
...	...																																	
31h	49																																	
32h	50																																	

8. Handling, Safety and Environment Requirements

Warning	
The display glass may break when it is dropped or bumped on a hard surface. Handle with care. Should the display break, do not touch the electrophoretic material. In case of contact with electrophoretic material, wash with water and soap.	
Caution	
The display module should not be exposed to harmful gases, such as acid and alkali gases, which corrode electronic components. Disassembling the display module. Disassembling the display module can cause permanent damage and invalidates the warranty agreements. Observe general precautions that are common to handling delicate electronic components. The glass can break and front surfaces can easily be damaged. Moreover the display is sensitive to static electricity and other rough environmental conditions.	
Data sheet status	
Product specification	This data sheet contains final product specifications.
Limiting values	
Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.	
Application information	
Where application information is given, it is advisory and does not form part of the specification.	

9. Optical Specifications

Measurements are made with that the illumination is under an angle of 45 degree, the detection is perpendicular unless otherwise specified

Symbol	Parameter	Conditions	Min	Typ.	Max	Units	Notes
R	White Reflectivity	White	30	35	-	%	8-1
CR	Contrast Ratio	Indoor	8:1		-		8-2
T update	Image update time	at 25 °C		26	-	sec	
Life		Topr		1000000times or 5years			

Notes: 8-1. Luminance meter: Eye-One Pro Spectrophotometer.

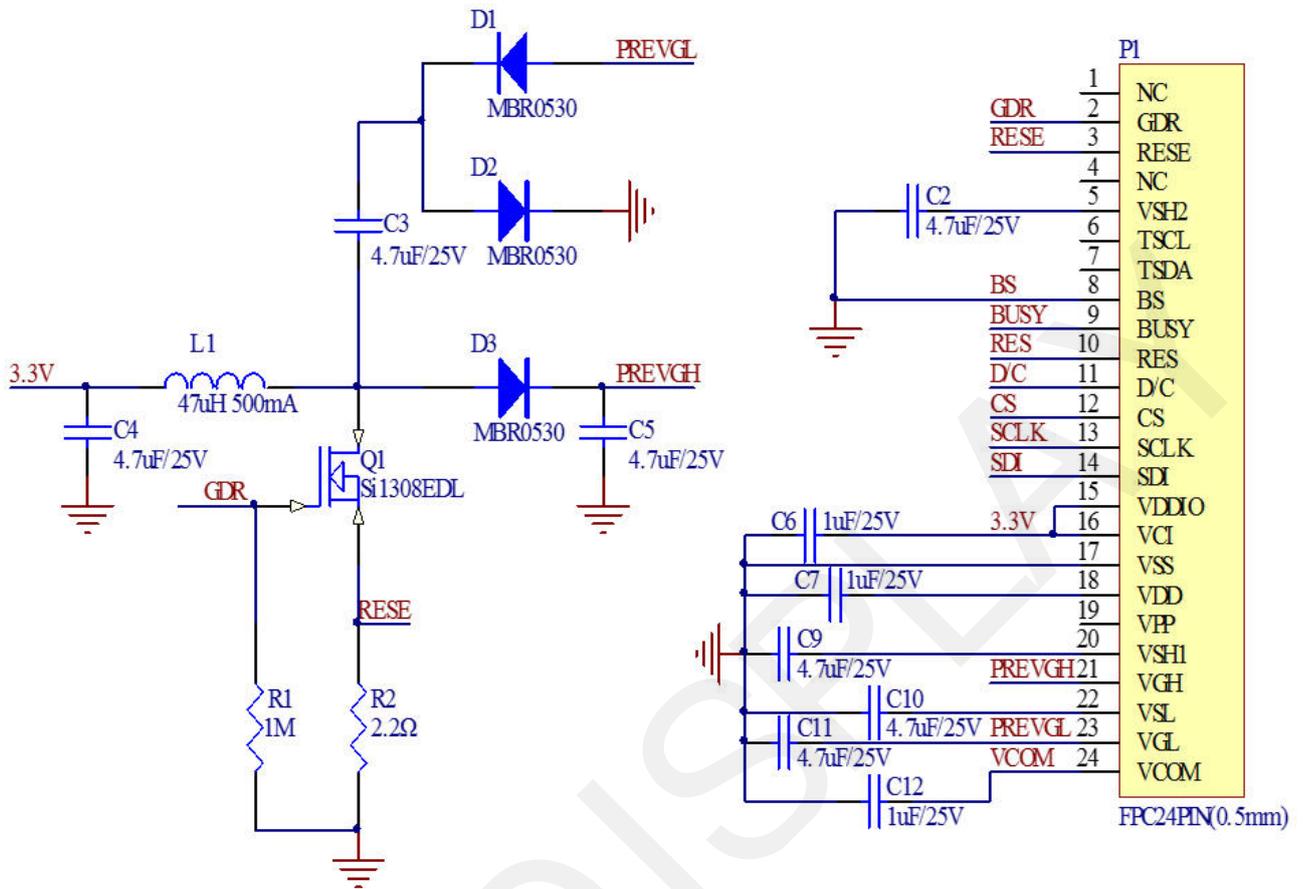
8-2. CR=Surface Reflectance with all white pixel/Surface Reflectance with all black pixels.

10. Reliability test

NO	Test items	Test condition
1	Low-Temperature Storage	T = -25°C, 240 h Test in white pattern
2	High-Temperature Storage	T=60° C, RH=35%, 240h Test in white pattern
3	High-Temperature Operation	T=40° C, RH=35%, 240h
4	Low-Temperature Operation	T=0° C, 240h
5	High-Temperature, High-Humidity Operation	T=40° C, RH=80%, 240h
6	High Temperature, High Humidity Storage	T=50° C, RH=90%, 240h Test in white pattern
7	Temperature Cycle	1 cycle:[-25°C 30min]→[+60°C 30 min] : 50 cycles Test in white pattern
8	UV exposure Resistance	765W/m ² for 168hrs,40 °C Test in white pattern
9	ESD Gun	Air+/-15KV;Contact+/-8KV (Test finished product shell, not display only) Air+/-8KV;Contact+/-6KV (Naked EPD display, no including IC and FPC area) Air+/-4KV;Contact+/-2KV (Naked EPD display, including IC and FPC area)

Note: Put in normal temperature for 1hour after test finished, display performance is ok.

11. Typical Application Circuit



12. Matched Development Kit

Our Development Kit designed for SPI E-paper Display aims to help users to learn how to use E-paper Display more easily. It can refresh black-white E-paper Display, three-color (black, white and red/Yellow) E-paper Display and four-color(black, white, red and yellow) Good Display `s E-paper Display. And it is also added the functions of USB serial port, FLASH chip, font chip, current detection ect.

Development Kit consists of the development board and the pinboard.

Supported development platforms include STM32, ESP32, ESP8266, Arduino UNO, etc. More details, please click to the following links:

STM32 <https://www.good-display.com/product/219.html>

ESP32 <https://www.good-display.com/product/338.html>

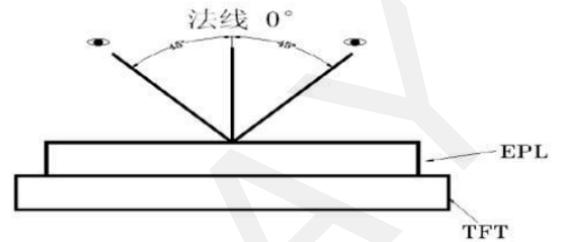
ESP8266 <https://www.good-display.com/product/220.html>

Arduino UNO <https://www.good-display.com/product/222.html>

13. Inspection method and condition

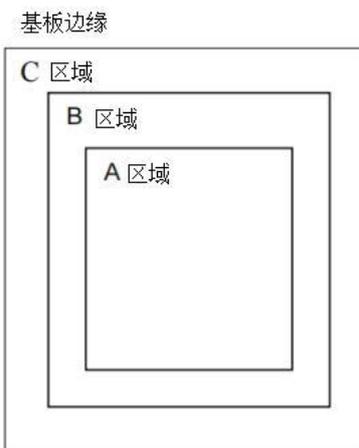
13. 1 Inspection condition

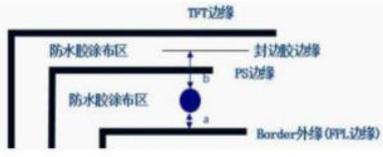
Item	Condition
Illuminance	800~1500 lux
Temperature	22°C ± 3°C
Humidity	55 ± 10 %RH
Distance	≥30cm
Angle	Vertical fore and aft 45
Inspection method	By eyes

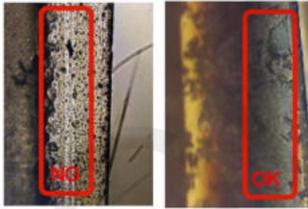


13. 2 Zone definition

- A Zone: Active area
- B Zone: Border zone
- C Zone: From B zone edge to panel edge



Inspection item		Figure	Inspection standard	Inspection method	MAJ / MIN
PS defect	Water proof film		1. Waterproof film damage, wrinkled, open edge, not allowed 2. Exceeding the edge of module (according to the lamination drawing) Not allowed 3. Edge warped exceeds height of technical file, not allowed	Check by eyes	MIN
RTV defect	Adhesive effect		Adhesive height exceeds the display surface, not allowed 1. Overflow, exceeds the panel side edge, affecting the size, not allowed 2. No adhesive at panel edge $\leq 1\text{mm}$, no exposure of wiring, allowed 3. No adhesive at edge and corner $1*1\text{mm}$, no exposure of wiring, allowed Protection adhesive, coverage width within $W \leq 1.5\text{mm}$, no break of adhesive, allowed	Check by eyes	MIN
	Adhesive re-fill		Dispensing is uniform, without obvious concave and breaking, bubbling and swell, not higher than the upper surface of the PS, and the diameter of the adhesive re-filling is not more than 8mm, allowed	Check by eyes	MIN
EC defect	Adhesive bubble		1. Effective edge sealing area of hot melt products $\geq 1/2$ edge sealing area; 2. Bubble $a+b \geq 1/2$ effective width, $N \leq 3$, spacing $\geq 5\text{mm}$, allowed No exposure of wiring, allowed	Check by eyes	MIN

Inspection item		Figure	Inspection standard	Inspection method	MAJ / MIN
EC defect	Adhesive effect		1. Overflow, exceeds the panel side edge, affecting the size, not allowed 2. No adhesive at panel edge $\leq 1\text{mm}$, no exposure of wiring, allowed 3. No adhesive at edge and corner $1*1\text{mm}$, no exposure of wiring, allowed 4. Adhesive height exceeds the display surface, not allowed	Visual, caliper	MIN
Silver dot adhesive defect	Silver dot adhesive		1. Single silver dot dispensing amount $\geq 1\text{mm}$, allowed 2. One of the double silver dot dispensing amount is $\geq 1\text{mm}$ and the other has adhesive (no reference to 1mm) Allowed	Visual	MIN
			Silver dot dispensing residue on the panel $\leq 0.2\text{mm}$, allowed	Film gauge	MIN
FPC defect	FPC wiring		FPC, TCP damage / gold finger peroxidation, adhesive residue, not allowed	Visual	MIJ
	FPC golden finger		The height of burr edge of TCP punching surface $\cong 0.4\text{mm}$, not allowed	Caliper	MIN
	FPC damage/cr ease		Damage and breaking, not allowed Crease does not affect the electrical performance display, allowed	Check by eyes	MIN

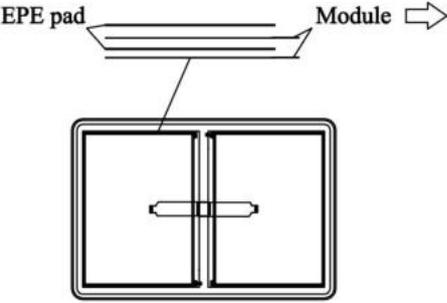
Inspection item		Figure	Inspection standard	Inspection method	MAJ/ MIN
Protective film defect	Protective film		Scratch and crease on the surface but no affect to protection function, allowed	Check by eyes	MIN
			Adhesive at edge $L \leq 5\text{mm}$, $W \leq 0.5\text{mm}$, $N=2$, no entering into viewing area	Check by eyes	MIN
Stain defect	Stain		If stain can be normally wiped clean by $> 99\%$ alcohol, allowed	Visual	MIN
Pull tab defect	Pull tab		The position and direction meet the document requirements, and ensure that the protective film can be pulled off.	Check by eyes/ Manual pulling	MIN
Shading tape defect	Shading tape		Tilt $\leq 10^\circ$, flat without warping, completely covering the IC.	Check by eyes/ Film gauge	MIN
Stiffener	Stiffener		Flat without warping, Exceeding the left and right edges of the FPC is not allowed. Left and right can be less than 0.5mm from FPC edge	Check by eyes	MIN
Label	Label/ Spraying code		The content meets the requirements of the work sheet. The attaching position meets the requirements of the technical documents.	Check by eyes	MIN

14. Packaging

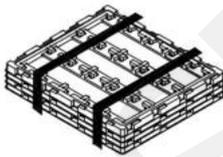
<i>CUSTOMER'S APPROVED:</i>	<i>DATE:2025.02.17</i>	<i>PAGE: 1/1</i>
-----------------------------	------------------------	------------------

PACKLING ORDER:

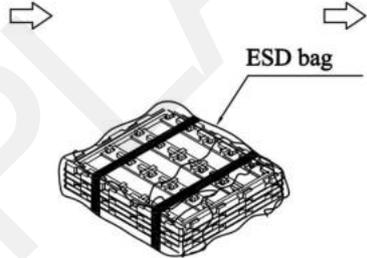
1) Putting 4 pcs Modules on each PET tray. Product with EPE pad on top. Place 2 pcs Modules in each pallet acupuncture point.



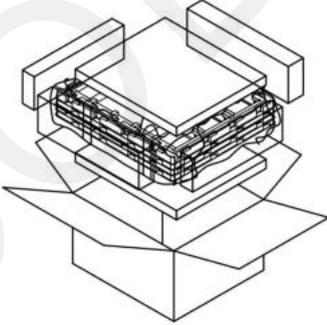
2) Putting 15 pcs PET trays together with 1 empty tray on the top of PET tray. the tray together with rubber band.



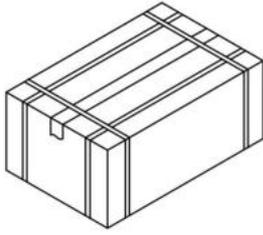
3) Insert in the ESD bag, add desiccant in the ESD bag.



4) Inside the outer box, The box is filled with EPE pad from top to bottom, front to back.



5) Packing finished



Note: 4x(16-1)=60pcs/Outcarton
Dimension (Out carton): 540*390*220mm

Drw:	Chk:	Apv:
------	------	------

15. Precautions

- (1) Do not apply pressure to the EPD panel in order to prevent damaging it.
- (2) Do not connect or disconnect the interface connector while the EPD panel is in operation.
- (3) Do not touch IC bonding area. It may scratch TFT lead or damage IC function.
- (4) Please be mindful of moisture to avoid its penetration into the EPD panel, which may cause damage during operation.
- (5) If the EPD Panel / Module is not refreshed every 24 hours, a phenomena known as "Ghosting" or "Image Sticking" may occur. It is recommended to refreshed the ESL /EPD Tag every 24 hours in use case. It is recommended that customer ships or stores the ESL / EPD Tag with a completely white image to avoid this issue
- (6) High temperature, high humidity, sunlight or fluorescent light may degrade the EPD panel's performance. Please do not expose the unprotected EPD panel to high temperature, high humidity, sunlight, or fluorescent for long periods of time.
- (7) For more precautions, please click on the link:
<https://www.good-display.com/news/80.html>